

IN THE CLAIMS

1-12 (Canceled)

13. (Currently Amended) A bipolar junction transistor comprising:

in a substrate, a first isolation structure spaced apart from a second isolation structure;

an emitter stack disposed above the substrate and between the first isolation structure and the second isolation structure;

a recess disposed immediately adjacent to the emitter stack and disposed between the emitter stack and the first isolation structure, wherein the recess exposes a collector tap, wherein the emitter stack and the recess share a boundary.

14-16 (Canceled)

17. (Original) The bipolar junction transistor according to claim 13, further including:

a buried layer disposed in the substrate between the first isolation structure and the second isolation structure.

18. (Original) The bipolar junction transistor according to claim 13, further including:

in the substrate, and epitaxial base layer disposed below the emitter stack;

a collector structure disposed in the substrate below the emitter stack; and

an intrinsic base structure disposed between the emitter stack and the collector structure.

19. (Original) The bipolar junction transistor according to claim 13, further including:
in the substrate, an epitaxial base layer disposed below the emitter stack;
a collector structure disposed in the substrate below the emitter stack;
a dielectric layer disposed above the substrate and below the emitter stack,
wherein the dielectric layer includes an emitter cut disposed above the collector structure;
and
an intrinsic base structure disposed between the emitter cut and the collector structure.

20. (Original) The bipolar junction transistor according to claim 13, further including:
in the substrate, a collector tap disposed in the recess, wherein the collector tap is selected from a P-- collector tap, a P- collector tap, a P collector tap, a P+ collector tap, a P++ collector tap, an N-- collector tap, an N- collector tap, an N collector tap, an N+ collector tap, and an N++ collector tap.

21. (Original) The bipolar junction transistor according to claim 13, wherein the substrate includes a bipolar-complementary metal oxide semiconductor (BiCMOS) structure.

22. (Original) The bipolar junction transistor according to claim 13, wherein the BJT is selected from a monojunction BJT device and a heterojunction BJT device.

23-26 (Canceled)

27. (Previously Presented) The bipolar junction transistor according to claim 13, wherein the collector tap is self-aligned.
28. (Previously Presented) The bipolar junction transistor according to claim 13, wherein the bipolar junction transistor is an NPN transistor, and wherein the collector tap is selected from an N-- collector tap, an N- collector tap, an N collector tap, an N+ collector tap, and an N++ collector tap.
29. (Previously Presented) The bipolar junction transistor according to claim 13, wherein the bipolar junction transistor is a PNP transistor, and wherein the collector tap is selected from a P-- collector tap, a P- collector tap, a P collector tap, a P+ collector tap, and a P++ collector tap.
30. (Previously Presented) The bipolar junction transistor according to claim 13, wherein the collector tap has no doping that is different from the substrate.
31. (Previously Presented) The bipolar junction transistor according to claim 13, wherein the recess is a contact corridor.